# **Technical Data Sheet**

# **1206** Package Chip LED with Inner lens

#### Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow
- solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS complaint version

#### Descriptions

- The 11-21 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

#### **Applications**

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

## **Device Selection Guide**

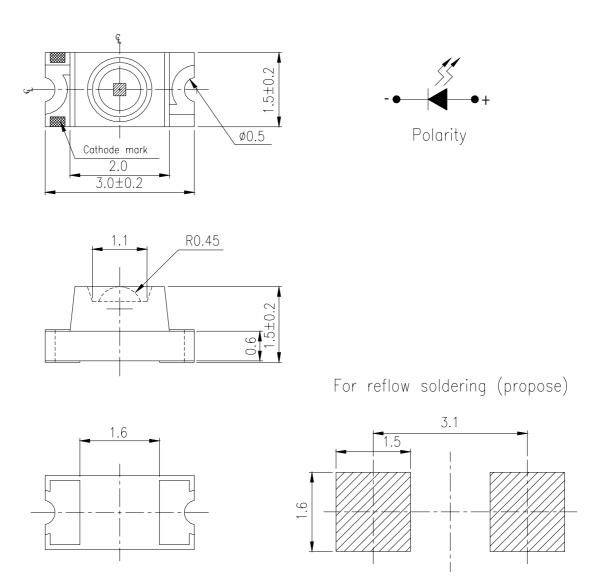
Part No.		L	
	Material	Emitted Color	Lens Color
11-21SYGC/S530-XX/TR8	AlGaInP	Brilliant Yellow Green	Water Clear



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# 11-21SYGC/S530-XX/TR8

# **Package Outline Dimensions**



**Notes:** The tolerances unless mentioned are  $\pm 0.1$ , unit=mm.

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## Absolute Maximum Ratings (Ta=25°C)

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Absolute Maximum Ratings (1a-25 C)					
Parameter	Symbol	Rating	Unit		
Reverse Voltage	VR	5	V		
Forward Current	IF	25	mA		
Operating Temperature	Topr	-40 ~ +85	°C		
Storage Temperature	Tstg	-40 ~ +90	°C		
Electrostatic Discharge	ESD	2000	V		
Power Dissipation	Pd	60	mW		
Peak Forward Current (Duty 1/10 @1KHz)	Ifp	60	mA		
Soldering Temperature	Tsol	Reflow Soldering : 260 $^{\circ}$ C for 10 sec. Hand Soldering : 350 $^{\circ}$ C for 3 sec.			

## Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	*Chip	Min.	Тур.	Max.	Unit	Conditio
		Rank					n
Luminous Intensity		E1	19	29			
		E2	29	39			
	Iv	E3	39	52		mcd	
		E4	52	62			
		E5	63	100			
Viewing Angle	2 <del>0</del> 1/2			60		deg	I <sub>F</sub> =20mA
Peak Wavelength	$\lambda_{p}$			575		nm	
Dominant Wavelength	λd			573		nm	
Spectrum Radiation Bandwidth	Δλ			20		nm	
Forward Voltage	$V_{\rm F}$		1.7	2.0	2.4	V	
Reverse Current	I <sub>R</sub>				10	$\mu A$	V <sub>R</sub> =5V

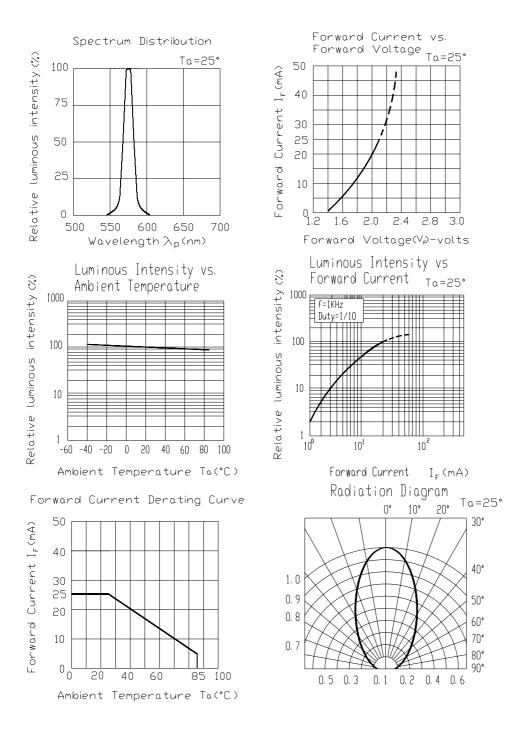
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#### **Typical Electro-Optical Characteristics Curves**

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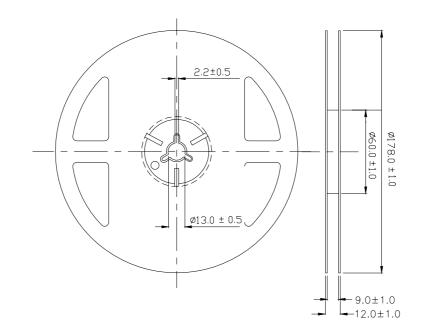
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#### Label explanation

- **CAT: Luminous Intensity Rank**
- HUE: Dom. Wavelength Rank
- **REF: Forward Voltage Rank**



#### **Reel Dimensions**

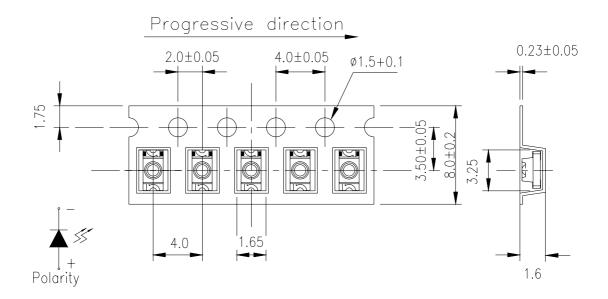


**Note:** The tolerances unless mentioned are  $\pm 0.1$ , Unit = mm.

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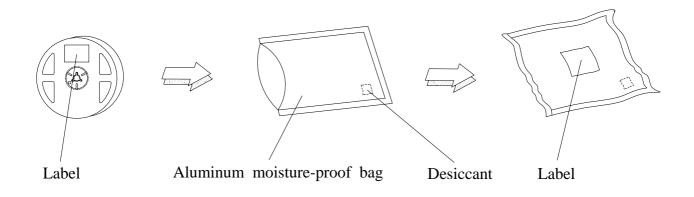
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# **Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel**



**Note:** The tolerances unless mentioned are  $\pm 0.1$ , Unit = mm.

# **Moisture Resistant Packaging**



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#### **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level : 90 %

LTPD : 10 %

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No.	Items	Test Condition Test Hours/Cycl		Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C ±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H : +100°C 15min ∫ 5 min L : -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H: +100°C 5min $\int 10 \sec$ L: -10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	<b>Temp.</b> : -40°℃	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85℃/ 85%RH	1000 Hrs.	22 PCS.	0/1

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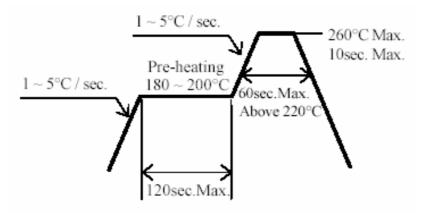
#### **Precautions For Use**

1. Over-current-proof

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Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change ( Burn out will happen ).

- 2. Storage
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at  $30^{\circ}$ C or less and 90%RH or less.
- 2.3 The LEDs should be used within a year.(To fit the MSL-2.)
- 2.4 After opening the package, the LEDs should be kept at  $30^{\circ}$ C or less and 70%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
- 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.
  Baking treatment : 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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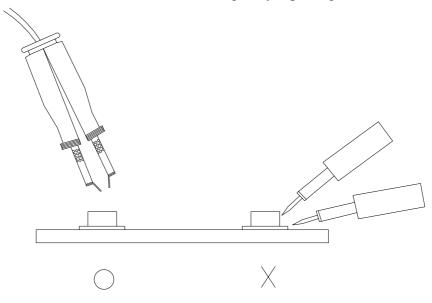
#### 4. Soldering Iron

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Each terminal is to go to the tip of soldering iron temperature less than  $350^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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